

Quad ± 90 V, ± 2 A, 3/5 levels, high speed ultrasound pulser

Datasheet — production data

Features

- 0 to ±90 V output voltage
- Up to 20 MHz operating frequency
- Embedded low-power, floating high-voltage drivers (external voltage rails can be also used)
- Mode operations:
 - 3/5-levels output waveform
 - ±2 A source and sink current
 - Down ≤20 ps jitter
 - Anti-cross conduction function
 - Low 2nd harmonic distortion
- Fully integrated clamping-to-ground function
 - 8 Ω synchronous active clamp
 - Anti-leakage on output node
- Dedicated half bridge for continuous wave (CW) operations
 - ≤0.1 W power consumption
 - ±0.6 A source and sink current
 - ≤10 ps jitter
- Fully integrated T/R switch
 - 13.5Ω on resistance
 - HV MOS topology to minimize current consumption
 - Up to 300 MHz BW
 - Receiver multiplexing function
- 2.4 V to 3.6 V CMOS logic interface
- Auxiliary integrated circuits
 - Noise blocking diodes
 - Fully self-biasing architecture
 - Anti-memory effect for all internal HV nodes
 - Thermal protection
 - Standby function
- Latch-up free due to HV SOI technology
- Very few external passive components needed



Applications

- Medical ultrasound imaging
- Pulse waveform generator
- NDT ultrasound transmission
- Piezoelectric transducers driver

Description

This monolithic, high-voltage, high-speed pulser generator features four independent channels. It is designed for medical ultrasound imaging applications, but it can also be used for driving other piezoelectric, capacitive or MEMS based transducers. The STHV748 comprises a controller logic interface circuit, level translators, MOSFET gate drivers, noise blocking diodes, and high-power P-channel and N-channel MOSFETs as the output stage for each channel, clampingto-ground circuitry, anti-leakage, anti-memory effect block, thermal sensor, and a T/R switch which guarantees an effective decoupling during the transmission phase. Moreover, the STHV748 includes self-biasing and thermal shutdown blocks. Each channel can support up to five active output levels with two half bridges. The output stage of each channel is able to provide ±2 A peak output current. In order to reduce power dissipation during continuous wave mode, a dedicated half bridge is available and the peak current is limited to 0.6 A.

Table 1. Device summary

Order code	Package	Packaging
STHV748QTR	QFN64	Tape and reel

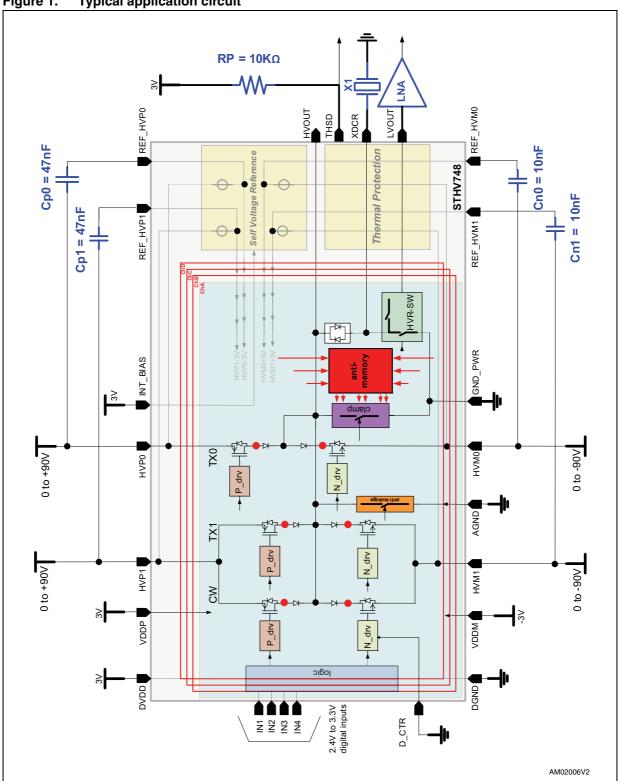
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Typical application circuit 1



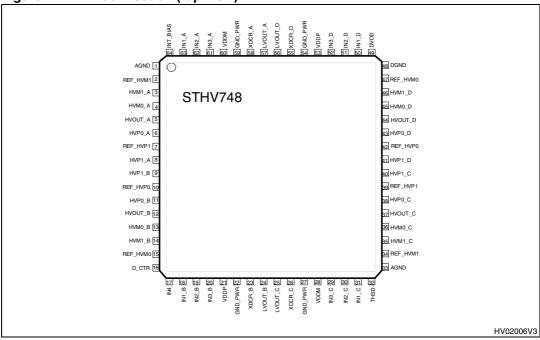


Pin settings STHV748

2 Pin settings

2.1 Connection

Figure 2. Pin connection (top view)



2.2 Description

Table 2. Pin description (P = power, A = analog, D = digital)

Pin N	Name	Name Function		Туре
1	AGND	Signal ground	I	Α
2	REF_HVM1	Supply for low side 1 gate driver	I	Р
3	HVM1_A	Negative high-voltage supply 1 channel A	I	Р
4	HVM0_A	Negative high-voltage supply 0 channel A	I	Р
5	HVOUT_A	Channel A, high-voltage output before noise blocking diodes	0	Р
6	HVP0_A	Positive high-voltage supply 0 channel A	I	Р
7	REF_HVP1	Supply for high side 1 gate driver	I	Р
8	HVP1_A	Positive high-voltage supply 1 channel A	I	Р
9	HVP1_B	Positive high-voltage supply 1 channel B	I	Р
10	REF_HVP0	Supply for high side 0 gate driver	I	Р
11	HVP0_B	Positive high-voltage supply 0 channel B	I	Р

STHV748 Pin settings

Table 2. Pin description (P = power, A = analog, D = digital) (continued)

Pin N	Name	Function	IN/OUT	Туре
12	HVOUT_B	Channel B, high-voltage output before noise blocking diodes	0	Р
13	HVM0_B	Negative high-voltage supply 0 channel B	1	Р
14	HVM1_B	Negative high-voltage supply 1 channel B	1	Р
15	REF_HVM0	Supply for low side 0 gate driver	I	Р
16	D_CTR	Delay control	1	Α
17	IN4	Input signal shared	1	D
18	IN1_B	Input signal channel B	I	D
19	IN2_B	Input signal channel B	1	D
20	IN3_B	Input signal channel B	I	D
21	VDDP	Positive low-voltage supply	1	Α
22	GND_PWR	Power ground	1	Р
23	XDCR_B	Channel B, high-voltage output	0	Р
24	LVOUT_B	Channel B, low-voltage output	0	Α
25	LVOUT_C	Channel C, low-voltage output	0	Α
26	XDCR_C	Channel C, high-voltage output	0	Р
27	GND_PWR	Power ground	1	Р
28	VDDM	Negative low-voltage supply	1	Α
29	IN3_C	Input signal channel C	1	D
30	IN2_C	Input signal channel C	1	D
31	IN1_C	Input signal channel C	1	D
32	THSD	Thermal shutdown pin	I/O	D
33	AGND	Signal ground	1	Α
34	REF_HVM1	Supply for low side 1 gate driver	1	Р
35	HVM1_C	Negative high-voltage supply 1 channel C	I	Р
36	HVM0_C	Negative high-voltage supply 0 channel C	I	Р
37	HVOUT_C	Channel C, high-voltage output before noise blocking diodes	0	Р
38	HVP0_C	Positive high-voltage supply 0 channel C	1	Р
39	REF_HVP1	Supply for high side 1 gate driver	1	Р
40	HVP1_C	Positive high-voltage supply 1 channel C	I	Р
41	HVP1_D	Positive high-voltage supply 1 channel D	1	Р
42	REF_HVP0	Supply for high side 0 gate driver	ı	Р
43	HVP0_D	Positive high-voltage supply 0 channel D	ı	Р
44	HVOUT_D	Channel D, high-voltage output before noise blocking diodes	0	Р

Pin settings **STHV748**

Pin N Name **Function** IN/OUT **Type** HVM0 D Negative high-voltage supply 0 channel D Ρ 45 ı 46 HVM1 D Negative high-voltage supply 1 channel D I Ρ Ρ 47 REF_HVM0 Supply for low side 0 gate driver I 48 **DGND** Logic ground ı Α DVDD 49 Positive logic supply ı Α 50 IN1_D Input signal channel D ı D 51 IN2_D Input signal channel D I D IN3_D Input signal channel D 52 ı D **VDDP** ı Positive low-voltage supply Α 53 ı Ρ GND_PWR Power ground 54 0 XDCR D Ρ 55 Channel D, high-voltage output Channel D, low-voltage output LVOUT_D 0 56 Α 0 57 LVOUT_A Channel A, low-voltage output Α 58 XDCR_A Channel A, high-voltage output 0 Ρ **GND PWR** Ρ 59 Power ground **VDDM** Negative low-voltage supply ı 60 Α 61 IN3 A Input signal channel A ı D IN2_A 62 Input signal channel A ı D 63 IN1_A Input signal channel A ı D

Table 2. Pin description (P = power, A = analog, D = digital) (continued)

2.3 Additional pin description

INT BIAS

Exposed-Pad

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The INT BIAS pin enables the internal reference generators. With INT BIAS=DVDD, the STHV748 internally generates the reference voltages on REF_HVP1/0 (pin - 7, 10, 39, 42) and REF_HVM1/0 (pin - 2, 15, 34, 47). These voltages are set at VDDP below HVP and respectively at:

I

I

D

Ρ

Enable internal supply generators

Substrate

- REF_HVM# = HVM# + VDDP
- REF HVP# = HVP# VDDP

After enabling INT_BIAS, a period of time is needed to charge the external reference capacitors (about 30 µs in a typical application).

Should INT_BIAS=DGND, it is necessary to apply an external voltage reference to the REF_HVM# and REF_HVP# pins.

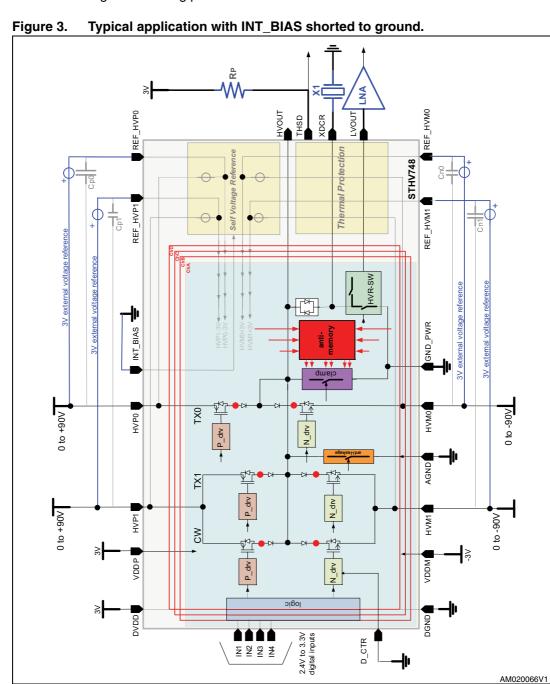
THSD is a thermal flag. Being the output stage of the THSD a Nch-MOS open-drain, an external pull-up resist or (Rp≥10 kΩ) connected to a positive low-voltage supply (see Figure 1) is required. If the internal temperature surpasses 153 °C, THSD goes down and all STHV748 channels are in HZ state. The thermal protection can be disabled, by connecting

STHV748 Pin settings

the THSD pin to a positive low voltage supply. THSD can be also shared among several STHV748 on the same PCB.

D_CTR can be used to optimize 2nd HD performances by tuning the fall propagation delay (tdf - see *Table 9*). If D_CTR is equal to ground, tdf has the nominal value. If D_CTR is varied from 2 V to 4.2 V, tdf can be changed from -1 ns to +600 ps with respect to the nominal value.

The exposed-pad is internally connected to the substrate of the package. It can be either left floating or connected to a ground via 100 V capacitance toward ground, in order to reduce the noise during the receiving phase.



Truth table and single channel block description 3

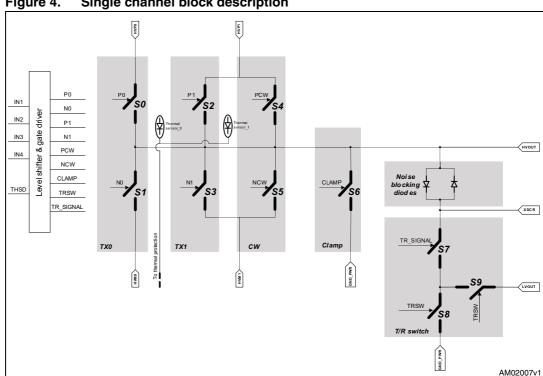


Figure 4. Single channel block description

Table 3. Truth table for one channel

Glob	al	Per	Per channel		State			Sw	itch	es ir	nterr	nal si	ate		
THSD	IN4	IN3	IN2	IN1	State	S0	S1	S2	S3	S4	S5	S6	S7	S8	S9
1	Х	х	0	0	Clamp	0	0	0	0	0	0	1	0	1	0
1	0	0	0	1	HVM0	0	1	0	0	0	0	0	0	1	0
1	0	0	1	0	HVP0	1	0	0	0	0	0	0	0	1	0
1	Х	0	1	1	T/R SW	0	0	0	0	0	0	1	1	0	1
1	0	1	0	1	HVM1	0	0	0	1	0	0	0	0	1	0
1	0	1	1	0	HVP1	0	0	1	0	0	0	0	0	1	0
1	0	1	1	1	HZ	0	0	0	0	0	0	0	0	1	0
1	1	1	1	1	T/R SW	0	0	0	0	0	0	1	1	0	1
1	1	0	0	1	Max. HVM0 and HVM1	0	1	0	1	0	0	0	0	1	0
1	1	0	1	0	Max. HVP0 and HVP1	1	0	1	0	0	0	0	0	1	0
1	1	1	0	1	CW HVM1	0	0	0	0	0	1	0	0	1	0
1	1	1	1	0	CW HVP1	0	0	0	0	1	0	0	0	1	0
0	Х	Х	х	х	HZ	0	0	0	0	0	0	0	0	1	0

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4 Power-up / Power-down voltage sequence

During the power up/power down phases,the following relationship must be always respected:

- VDDP >= DVDD
- HVM0 <= HVM1</p>
- HVP0 >= HVP1

It is recommended to power up the low voltage supplies before the high voltage supplies.

Electrical data STHV748

5 Electrical data

5.1 Absolute maximum ratings

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
AGND	Analog ground reference (1)	0	V
DGND	Digital ground	-300 to 300	mV
GND_PWR	Power ground	-1.2 to 1.2	V
VDDP	Positive supply voltage	-0.3 to 3.9	V
VDDM	Negative supply voltage	0.3 to -3.9	V
DVDD	Positive logic voltage	-0.3 to VDDP	V
HVP0	TX0 high-voltage positive supply	95	V
HVP1	TX1 high-voltage positive supply	0 to HVP0	V
HVM0	TX0 high-voltage negative supply	-95	V
HVM1	TX1 high-voltage negative supply	0 to HVM0	V
REF_HVP#	High-voltage positive gate supply	-0.3 < HVP - REF_HVP < 3.6	V
REF_HVM#	High-voltage negative gate supply	-0.3 < REF_HVM - HVM < 3.6	V
XDCR	High-voltage output	-95 to 95	V
HVOUT	High-voltage output before noise blocking diodes	-95 to 95	V
LVOUT	Low-voltage output	-1 to 1	V
DIG I/O	Digital input specified in Table 2	-0.3 to DVDD + 0.3	V
D_CTR	Delay control	-0.3 to 4.6	V
T _{OP}	Operating temperature range	-40 to 125	°C
T _{STG}	Storage temperature range	-65 to 150	°C

^{1.} AGND is the ground reference for all the other voltages.

Note:

Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

Table 5. Thermal data

Symbol	Parameter	Value	Unit
$R_{th,JA}$	Thermal resistance junction-ambient	30 ⁽¹⁾	°C/W

This value is given for a two layer PCB (2S2P) and it's strongly sensitive to PCB layout. Increasing the number of PCB layers and/or adding heat sinks vias, the thermal resistance value decreases.

6 Operating supply voltages and average currents

Operation conditions, unless otherwise specified, only ONE channel on, no load, HV=90 V, TX0 and TX1 on, INT_BIAS=DVDD, DVDD=3 V, VDDP=3 V and VDDM=-3 V

Table 6. Supply voltages and average currents

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
VDDP	Positive supply voltage		2.7	3	3.6	V
I _{VDDP}	Desitive events everent	PW mode ⁽¹⁾			1.5	mA
I _{VDDP_Q}	Positive supply current	Standby mode (2)		1.1		mA
VDDM	Negative supply voltage		-2.7	-3	-3.6	V
I _{VDDM}	No gotivo ovenhy overent	PW mode	-1.5			mA
I _{VDDM_Q}	Negative supply current	Standby mode		-800		μΑ
DVDD	Positive logic voltage		2.4	3	min(3.6,V DDP+0.3)	V
I_DVD	Logic supply current	PW mode			100	μΑ
I_ _{DVD_Q}		Standby mode			85	μΑ
HVP	High-voltage positive supply		0		90	V
I _{HVP}	HV positive supply current	PW mode			1	mA
I _{HVP_Q}	The positive supply current	Standby mode			350	μΑ
HVM	High-voltage negative supply		-90		0	V
I _{HVM}	LIV pogotivo gunniu gurrant	PW mode	-1			mA
I _{HVM_Q}	HV negative supply current	Standby mode	-350			μΑ
HVP-REF_HVP	High-voltage positive gate supply		2.7	3	3.6	V
REF_HVM-HVM	High-voltage negative gate supply		2.7	3	3.6	V
D_CTR	Delay control		0		4.2	V

^{1.} In PW pulse wave mode the average current is measured over $T_{w time}$ (see Figure 6).

6.1 Digital inputs

Table 7. Digital inputs

Symbol	Parameter	Min.	Max.	Units
IN1_#, IN2_#, IN3_#, IN4, INT_BIAS, THSD	Input logic high-voltage	0.8 DVDD	DVDD	V
IN1_#, IN2_#, IN3_#, IN4, INT_BIAS, THSD	Input logic low-voltage	0	0.2 DVDD	V

^{2.} In standby mode all channels are in HZ and INT_BIAS= AGND"

6.2 Output signals

Table 8. Output signals

Symbol	Parameter	Min.	Max.	Units
HVOUT	High-voltage output before noise blocking diodes	-90	90	V
XDCR	High-voltage output	-90	90	٧
LVOUT	Low-voltage output	-1	1	٧
THSD	Thermal shutdown pin	0	3	V

7 Electrical characteristics

Table 9. Static electrical characteristics (1)

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
		HVP# =10 V, HVM# =-10 V, HVOUT=0 V	1.1	1.30		Α
I _N	Saturation current S1 - S3	HVP# =25 V, HVM# =-25 V, HVOUT=0 V		1.70		Α
		HVP# =90 V, HVM# =-90 V, HVOUT=0 V		2		Α
		HVP# =10 V, HVM# =-10 V, HVOUT=0 V	1	1.30		Α
I _P	Saturation current S0 - S2	HVP# =25 V, HVM# =-25 V, HVOUT=0 V		1.70		Α
		HVP# =90 V, HVM# =-90 V, HVOUT=0 V		2		Α
I _{NCW}	Saturation current S5	HVP1=10 V, HVM1=-10 V, HVOUT=0 V	300	350		mA
I _{PCW}	Saturation current S4	HVP1=10 V, HVM1=-10 V, HVOUT=0 V	390	480		mA
I _{CL}	Saturation current S6	HVOUT=25 V		1.5		Α
R _{ON_CLAMP}	On resistance S6	HVOUT=1 V		8		Ω
	Output leakage current, per channel	HVP# = 90 V, HVM# = -90 V, HVOUT=0 V		1		
IL		HVP# = 90 V, HVM# = -90 V, HVOUT=-90 V		1		μΑ
		HVP# = 90 V, HVM# = -90 V, HVOUT=+90 V		1		
P _{SB}	Power dissipation in standby	HVP# = 90 V, HVM# = -90 V, HVOUT=0 V, INT_BIAS=DGND		4		μW
36	mode	HVP# = 90 V, HVM# = -90 V, HVOUT=0 V		126	150	mW
P _{RX}	Power dissipation in HVR_SW state	HVP# = 30 V, HVM# = -30 V, INT_BIAS =0, all channels in receiving phase		30		mW
V _{REFP}	HVP# - REF_HVP#	HVP# = 10 V, HVM# = -10 V, HVOUT=0 V	0.8 VDDP		1.2 VDDP	V
V _{REFN}	REF_HVM# - HVM#	HVP# = 10 V, HVM# = -10 V, HVOUT=0 V	0.8 VDDP		1.2 VDDP	V
T _{OTP} (2)	Overtemperature threshold	HVP# =10 V, HVM# =-10 V	130	153	160	°C
T _{HYS}	OTP hysteresis	HVP# =10 V, HVM# =-10 V		40		°C

Table 9. Static electrical characteristics (1) (continued)

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
C _{T/R SW}	T/R SW capacitance	LVOUT=0 V		40		pF
R T/R SW_ON	T/R SW on resistance	HVP# =10 V, HVM# =-10 V, XDCR=0 V, LVOUT=0.2 V		13.5	15.5	Ω
R T/R SW_OFF	T/R SW off resistance	HVP# =10 V, HVM# =-10 V, XDCR=1 V, LVOUT=0 V	1			GΩ
VDROP_C W	Voltage drop between HVP1 and XDCR	HVP# =10V, HVM# =-10V, I _{SINK_XDCR} =50 mA	2.58	2.79	2.9	V
	Voltage drop between XDCR and HVM1	HVP# =10V, HVM# =-10V, I _{SOURCE_XDCR} =50 mA	2.58	2.86	2.9	V

^{1.} Operating conditions, unless otherwise specified, INT_BIAS=DVDD, HVP# = 90 V, HVM# = -90 V, VDDP = 3 V, VDDM = -3 V, DVDD = 3 V, TROOM = 25 °C.

Table 10. AC electrical characteristics (1)

Symbol	Parameter	Test condition		Тур.	Max.	Units
f	Maximum output frequency		16			MHz
'	waximum output frequency	50 pF//200 Ω		22		MHz
f _{CW}	Maximum output frequency CW	HVP1 =5 V, HVM1 = -5 V, continuous wave mode		20		MHz
f _{BW}	Output frequency BW	HVP1 = 50 V, HVM1 = -50 V, continuous wave mode, 50 pF//200 Ω		10		MHz
t _j	Output jitter			20		ps, rms
t _{j-CW}	CW output jitter HVP1 =10 V, HVM1 = -10 V, continuous wave mode			5		ps, rms
t _f	Fall time			28		ns
t _r	Rise time			28		ns
t _{dr}	Rise propagation delay			24		ns
t _{df}	Fall propagation delay			24		ns
T/R SW	T/R SW turn-on / turn-off time			170		ns
		1 pulse f = 1.7 MHz		-40		dBc
HD2	2 nd harmonic distortion	1 pulse f = 5 MHz		-40		dBc
HDZ		5 pulses f = 1.7 MHz		-40		dBc
		5 pulses f = 5 MHz		-40		dBc
HD2PC	Pulse cancellation	f = 1.7 MHz original and inverted pulse		-40		dBc
	i dise cancenation	f = 5 MHz original and inverted pulse		-40		dBc

^{2.} Guaranteed by bench characterization.

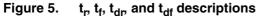
Table 10. AC electrical characteristics (1)

Symbol	Parameter	Test condition		Тур.	Max.	Units
BVD	Burst voltage drop	1 st to 128 th pulse HVP1 = 10 V, HVM1 = -10 V		2		%
	Power dissipation, all channels	CW mode, f = 5 MHz, HVP1 = 5 V, HVM1 = -5 V, no load	390			mW
P _{D_CW}	Power dissipation, one channel	CW mode, f = 5 MHz, HVP1 = 5 V, HVM1 = -5 V			320	11144
T/R SW _{SPIKE}	T/R SW spike on XDCR and LVOUT			100		mV_{pp}
X _{TALK}	Cross talk between channels.	Ampl(2ch)/Ampl(1ch), 50 pF//200 Ω		-40		db

^{1.} Operating conditions, unless otherwise specified, HVP# = 90 V, HVM# = -90 V, VDDP = 3 V, VDDM = -3 V, DVDD = 3 V, V, INT_BIAS = DVDD, (HVP-REF_HVP) = 3 V, (REF_HVM-HVM) = 3 V, XDCR load C = 300 pF//R = 100 Ω , LVOUT load C = 20 pF//200 Ω T_{ROOM} = 25 °C.

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8 Timings



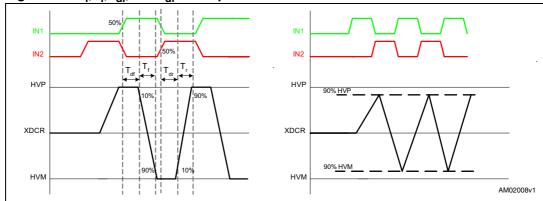
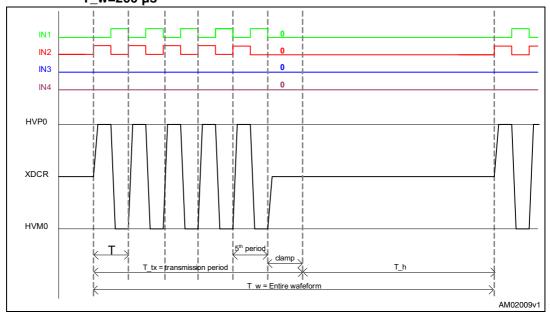


Figure 6. PW example 5 periods, HVP0 = 90 V, HVM0 = -90 V, T=200 ns, T_tx=1.2 μ s, T_w=200 μ s



STHV748 Timings

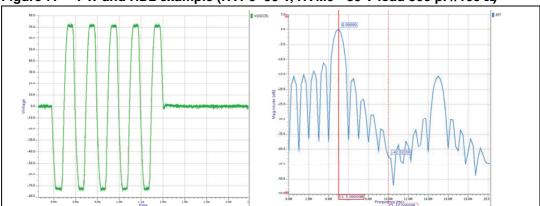
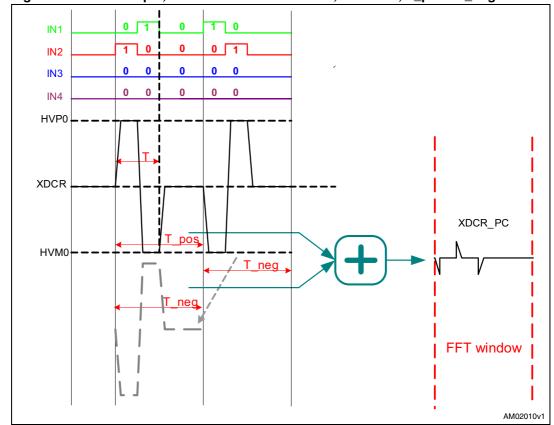


Figure 7. PW and HD2 example (HVP0=80 V, HVM0=-80 V load 300 pF//100 Ω)





Timings STHV748

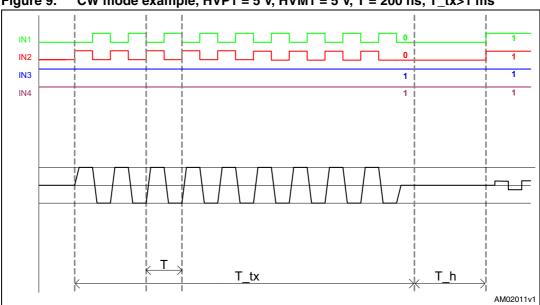
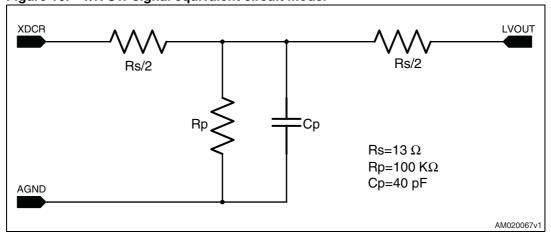


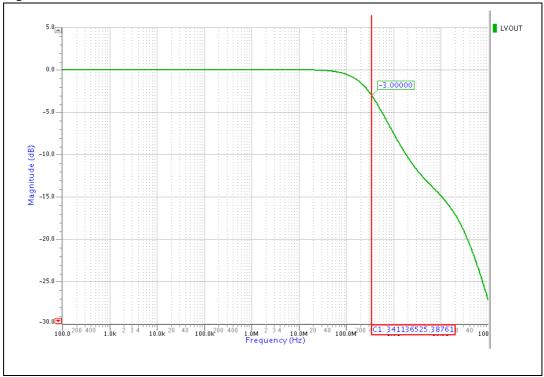
Figure 9. CW mode example, HVP1 = 5 V, HVM1 = 5 V, T = 200 ns, $T_tx>1 ms$

Figure 10. T/R SW signal equivalent circuit model



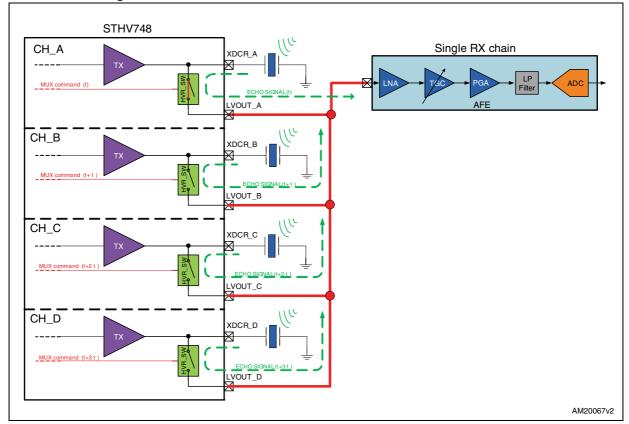
STHV748 Timings

Figure 11. T/R SW bandwidth



Timings STHV748

Figure 12. Possible external connection for LVOUT outputs with T/R SW in multiplexing driving configuration



9 Oscilloscope acquisitions

Figure 13. TX0 = ± 60 V positive-negative pulses and immediately after TX1 = ± 30 V positive-negative pulses, load 300 pF // 100 Ω



Figure 14. Five-levels HV output voltage



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Figure 15. CW operations at 6 MHz

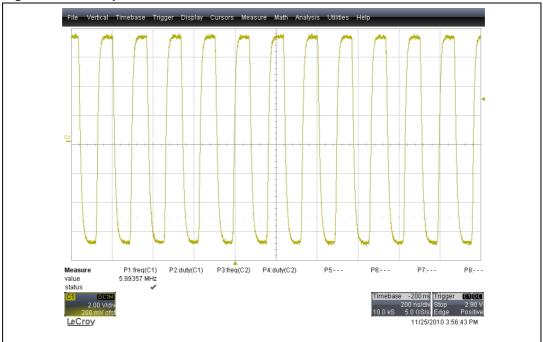
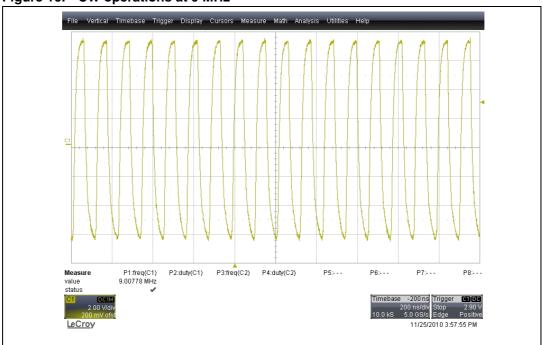


Figure 16. CW operations at 9 MHz



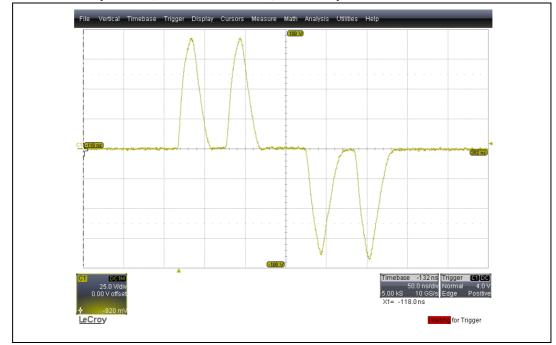


Figure 17. Two positive and two negative "short pulses" with 10 ns time width for inputs IN#, HVP/N/0/1 = ±90 V, load 300 pF // 100 Ω

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10 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 11. QFN64 9 x 9 x 1.0 mm 64 pitch 0.50 mechanical data

Dim	Min.	n. Typ. N		
Α	0.8	0.9	1	
A1		0.02	0.05	
A2		0.65	1	
A3		0.2		
b	0.18	0.25	0.3	
D	8.85	9	9.15	
D1		8.75		
D2	See exposed pad variation			
E	8.85	9	9.15	
E1		8.75		
E2	See exposed pad variation			
е		0.5		
L	0.35	0.4	0.45	
Р			0.6	
K			12	
ddd			0.08	

Table 12. Exposed-pad variation

Variation	6D2			E2			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	4.1	4.25	4.4	4.1	4.25	4.4	
В	4.55	4.7	4.85	4.55	4.7	4.85	
С	6.95	7.1	7.25	6.95	7.1	7.25	
D	7.15	7.3	7.45	7.15	7.3	7.45	

Note: QFN64 used for STHV748 has D variation option.

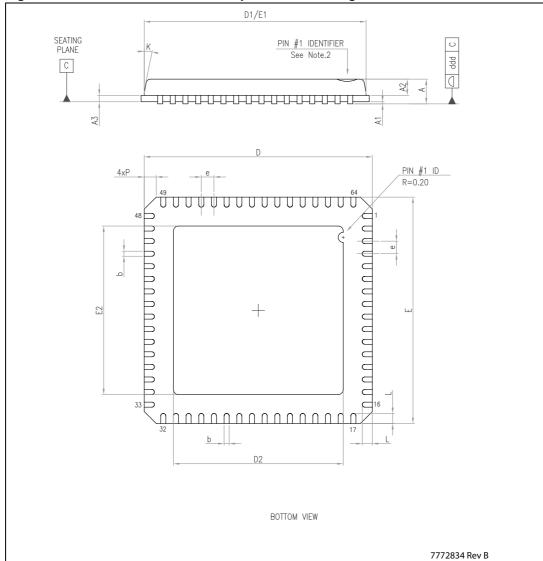
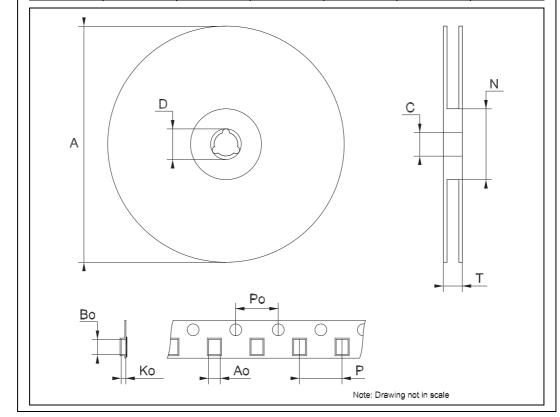


Figure 18. QFN64 9 x 9 x 1.0 mm 64 pitch 0.50 drawing

Figure 19. QFN64 9 x 9 x 1.0 mm 64 tape and reel information

DIM.		mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Α			330			12.992	
С	12.8		13.2	0.504		0.519	
D	20.2			0.795			
N	60			2.362			
Т			30.4			1.196	
Ao	12.25		12.45	0482		0.490	
Во	12.25		12.45	0482		0.490	
Ko	2.1		2.3	0.083		0.091	
Po	3.9		4.1	0.153		0.161	
Р	15.9		16.1	0.626		0.639	



STHV748 Revision history

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Table 13. Document revision history

Date	Revision	Changes	
20-Jan-2010	1	Initial release.	
17-Feb-2010	2	Updated typo on coverpage.	
09-Nov-2011	3	Updated Table 6: Supply voltages and average currents, Table 9: Static electrical characteristics and Table 10: AC electrical characteristics. Minor text changes.	
11-May-2012	4	Updated the entire <i>Table 6: Supply voltages and average currents</i> title included. Updated title in <i>Figure 6: PW example 5 periods, HVP0 = 90 V, HVM0 = -90 V, T=200 ns, T_tx=1.2 μs, T_w=200 μs.</i> Minor text changes.	

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